

AMENDMENTS TO THE SPECIFICATION:

(1) On page 3 of the specification, please amend paragraph [0015] as follows:

[0015] ~~Fig. 7 illustrates a perspective view~~ Figs. 7A and 7B illustrate perspective views of one embodiment of a clamped assembly constructed according to aspects of the present disclosure, wherein Fig. 7B is a detail view of a portion of Fig. 7A.

(2) On page 4 of the specification, please amend paragraph [0020] as follows:

[0020] In one embodiment, the beam modification components 120a-j may be coupled to the assembly substrate 110 by connector/socket pairs, such as those shown in U.S. Patent Application No. 10/778,460, filed February 13, 2004, entitled "MEMS MICROCONNECTORS AND NON-POWERED MICROASSEMBLY THEREWITH," having Kenneth Tsui, Aaron Geisberger, and George Skidmore names as inventors, which is incorporated by reference herein in its entirety. For example, each of the beam modification components 120a-j may include an integral connector for engaging a corresponding socket 130 on the assembly substrate 110. The connectors may also be separate components bonded or otherwise coupled to the beam modification components 120a-j. The assembly substrate 110 may also include traces or other conductive members 115 electrically connected to corresponding sockets 130 for providing current and/or biasing signals to the ones of the beam modification components 120a-j.

(3) On page 11, please amend paragraph [0049] as follows:

[0049] Referring to ~~Fig. 7~~ Figs. 7A and 7B. collectively, ~~illustrated is a~~ are perspective views of another embodiment of an assembly 700 of a beam modification component 710 and an assembly substrate 720, wherein Fig. 7B is a detail view of a portion of Fig. 7A. The assembly 700 may be included in the microcolumn 100 of Fig. 1. The beam modification component 710 and the assembly substrate 720 may be substantially similar to any of the beam modification components and assembly substrates described above. The assembly 700 also includes one or more clamp components 730 assembled to the assembly substrate 720 and the beam modification component 710.